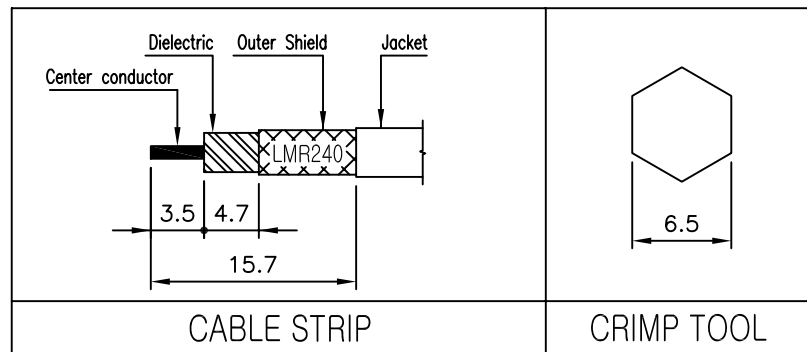
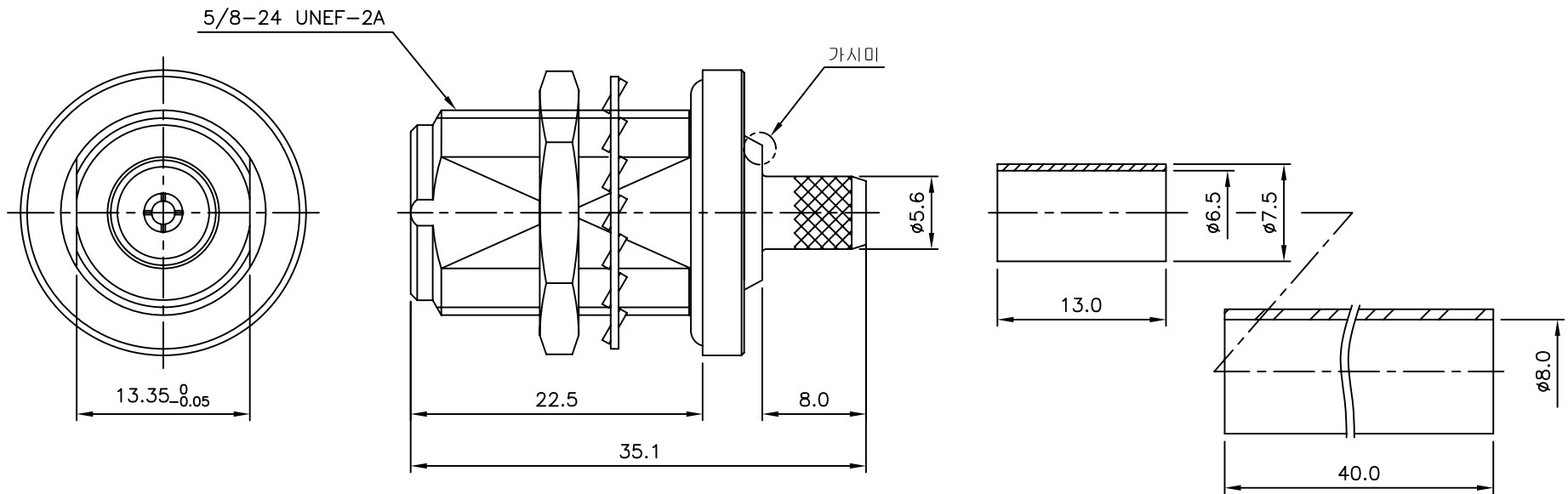


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	E.H.KIM	I.C.KIM	2013.03.20.
1	포장사양 개별포장 → Bulk포장 변경	S.Y.EUN	I.C.KIM	2020.11.16.



9	BONDING TUBE	1			ATU00351-N/1
8	WASHER	1	BsS	Nickel Plate	DWA00045-5/1
7	NUT	1	MBsBD	Nickel Plate	DNT00033-5/1
6	INSULATOR	1	TEFLON		DIN02098-N/1
5	FERRULE	1	MBsBD	Nickel Plate	DFE00062-5/2
4	GASKET	1	NBR		DGK00046-N/1
3	CONTACT	1	BeCu	Gold Plate	DCT02796-5/1
2	BODY	1	MBsBD	Nickel Plate	DBD03286-5/1
1	BODY	1	MBsBD	Nickel Plate	DBD03224-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2020. 11. 16.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE N50 CABLE JB (F/N) LMR240(50Ω)
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	UNIT	A4 DWG NO. CN02958-7/1 REVISION 1 SHEET 1 of 1
		2/1	mm	